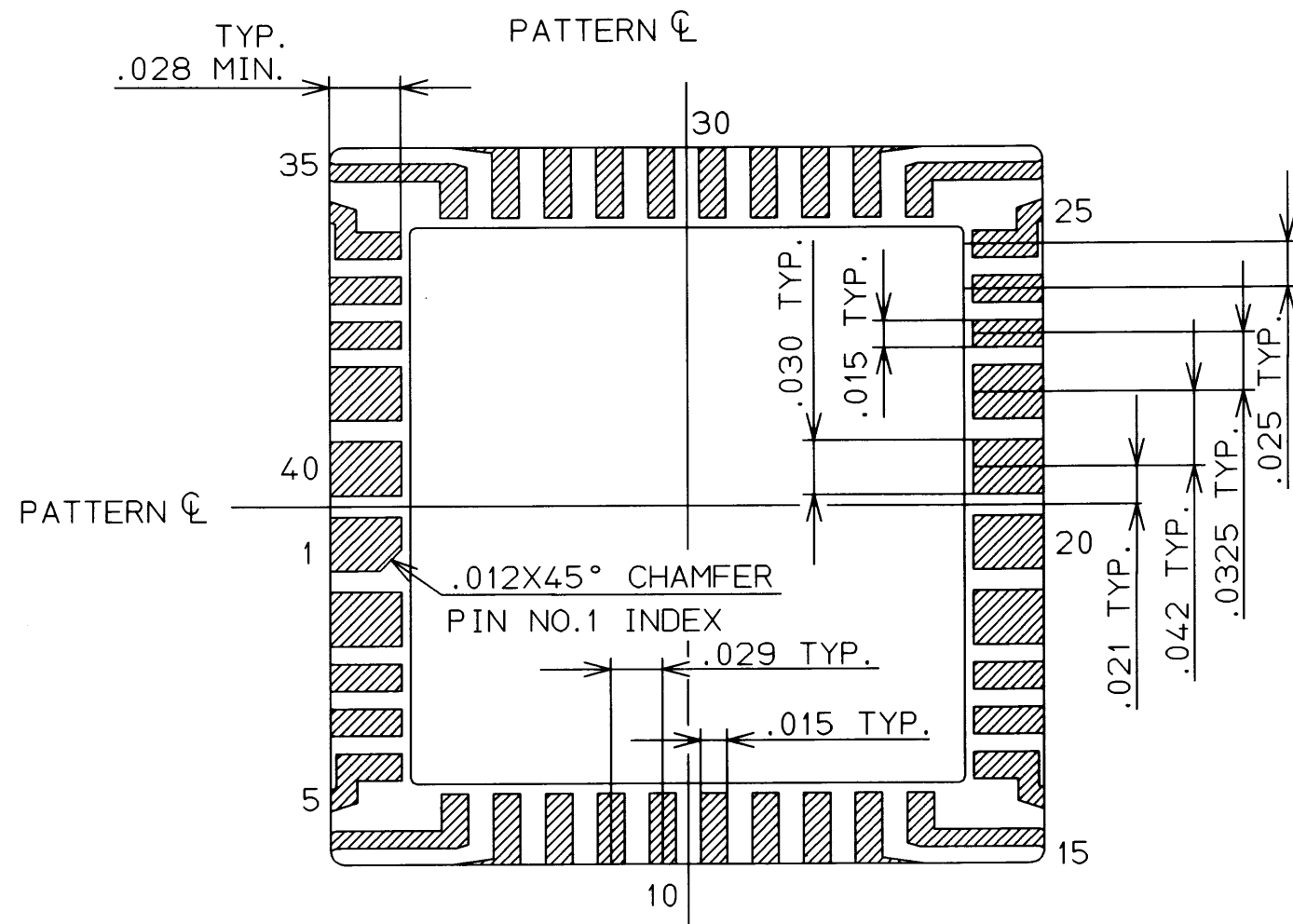


PART NO.	INDEX MARK	LEAD TIED DOWN
01	+	NIL.
02	+	NO.1 ONLY

MODIFICATION		DATE	DRAWN	CHECKED	APPROVED	NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
REDRAWN (CONVERTED CAD DATA) CHANGED		APR. 4 '97	S. TH	S.F. K.I.	T. A	40 LEAD SIDE BRAZED PACKAGE	UNLESS OTHERWISE SPECIFIED ±.005 THIRD ANGLE PROJECTION	T. H	K. M		SEP. 16 '78
						SCALE 4/1		S. Inada			
						KYOCERA		K. M			
						KYOCERA CORPORATION KYOTO JAPAN		T. Arim			
								DRAWING NO. KD-78300-F		SHEET 1/2	

SB040I300-2 S=0 D=1 SB040I300-1 S=0 D=0



NOTES.

1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
2. SEAL AREA TO BE METALLIZED.
3. DIE ATTACH AREA TO BE METALLIZED.
4. SEAL RING TO BE FLOATING FROM ANY PINS.
5. LEAD RESISTANCE:  
 PIN NO.1,2,19,20,21,22,39,40 ----0.15ΩMAX.  
 PIN NO.9,10,11,12,29,30,31,32 ----0.075ΩMAX.  
 OTHER LESS THAN 1.2ΩMAX.

BONDING PATTERN

MODIFICATION						NAME 40 LEAD SIDE BRAZED PACKAGE	TOLERANCE UNLESS OTHERWISE SPECIFIED	DRAWN S.TH	CHECKED S.F/K.I	APPROVED T.A	DATE APR.4.'97
						SCALE 10 / 1	MATERIAL	THIRD ANGLE PROJECTION		DRAWING NO. KD-78300-F	SHEET 2/2
	CHANGED		DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION KYOTO JAPAN			